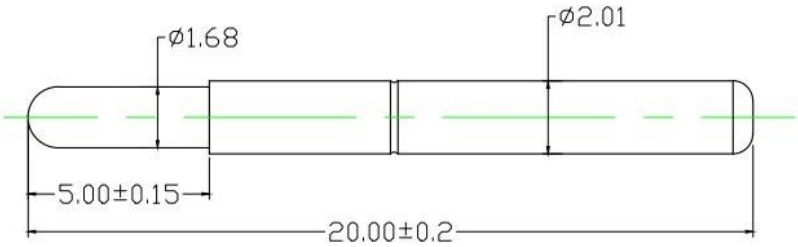


□□□□

□□□□	SF-P125-J
□□□	1.90mm
□□□□□□□	□□□□□□□□□□:1.35 □□□□□□□□□□:1.40mm
□□□□□□□	4.5mm
□□□	180±20%gf@load4.5mm
□□□□□	3A
□□□□	≤50mΩ
MOQ	100□
□□□	T/T
□□	□□□□□□□□□□ 5 □ 10 □

□□ □□□□□

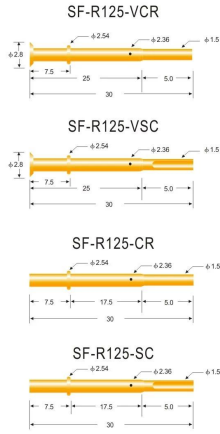


Materials(Plated) (材質與鍍層) :
Barrel(針套) : Brass(黃銅) , Au on Ni Plated
Plunger(針軸) : Brass(黃銅) , Ni Plated
Spring(彈弓) : SUS (不銹鋼線) , /

Specifications (技術要求) :
Full Stroke(滿行程) : 4.5mm
Spring Force(彈力) : 180±20%gf@ load 4.5mm

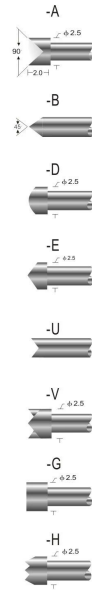
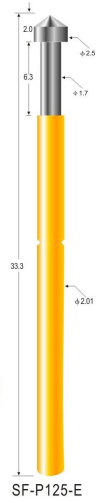
					名 称:				胜峰科技	
					SF-P125-J (L20)					
									说明:	
									1. 所有尺寸单位为mm	
									2. 未注图示尺寸公差: 按GB1804-79 11级精度执行	
标记	处数	更改文件号	签 字	日 期	图 样 标 记	视 图	质 量	比 例	图纸编号:	
设 计			标 准 化		图 样 标 记	视 图	质 量	比 例		
校 对			审 定		S	A		1:1		
审 核			制 图	RSS						
工 艺			日 期	2020-09-24	共 1 页	第 1 页				

SF-P125

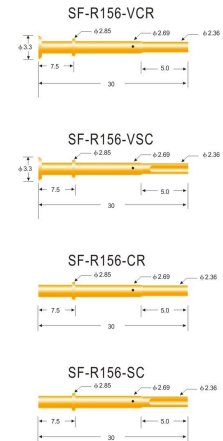


Probe specifications SF-P125(技术规格)

- Recommended minimum center(最小间距): 3.17mm(.1248")
- Mounting hole size(钻孔尺寸): 压克力: 2.40mm(.0945")
电木板、玻璃纤维板: 2.45mm(.0965")
- Full travel(行程): 6.30(.2480")
- Spring force(弹簧压力): 200g
- Materials and finishes(材料及涂饰):
Plunger: Be Cu, Rh plated;
Barrel: Brass, Gold plated
Spring: Stainless steel
- Current rating(额定电流): 5A(安培)
- Contact resistance(接触电阻): 50mΩ(毫欧姆)
- Connections(接线形式):
Crimp: R125-VCR, R125-CR
Solder cup: R125-VSC, R125-SC

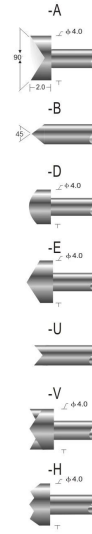
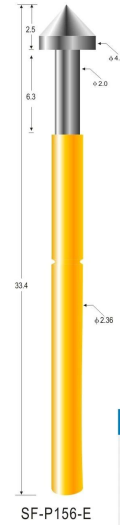


SF-P156



Probe specifications SF-P156(技术规格)

- Recommended minimum center(最小间距): 4.75mm(.1870")
- Mounting hole size(钻孔尺寸): 压克力: 2.75mm(.1083")
电木板、玻璃纤维板: 2.80mm(.1102")
- Full travel(行程): 6.30(.2480")
- Spring force(弹簧压力): 250g
- Materials and finishes(材料及涂饰):
Plunger: Be Cu, Rh plated;
Barrel: Brass, Gold plated
Spring: Stainless steel
- Current rating(额定电流): 5A(安培)
- Contact resistance(接触电阻): 50mΩ(毫欧姆)
- Connections(接线形式):
Crimp: R156-VCR, R156-CR
Solder cup: R156-VSC, R156-SC







1. raw material warehouse



2. Lathe workshop



3. Assemble workshop



4. Quality inspection



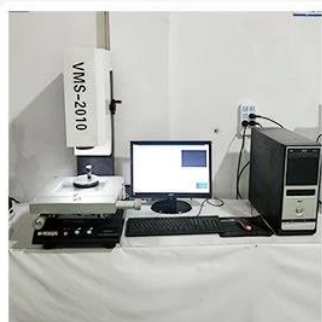
5. Finished products



6. Packing



Measuring Equipment >



Measuring Equipment:

1. Agilent current testing;
2. Quadratic element measurement
3. Load Curve Meter
4. Bond Test
5. Life Fatigue Test





- 1.PCB ICT FCT
2. () 2
- 3.BGA
- 4.LM QZ VZ
- 5.
- 6.&/
- 7.POM

1. 24
- 2.OEM
- 3.
- 4.